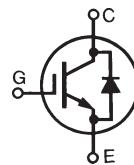


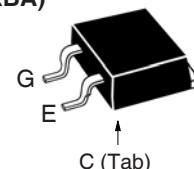
**High Voltage, High Gain  
BIMOSFET™ Monolithic  
Bipolar MOS Transistor**

**IXBA16N170AHV  
IXBT16N170AHV**

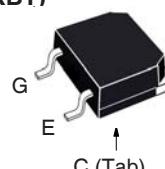
**V<sub>CES</sub> = 1700V  
I<sub>C25</sub> = 16A  
V<sub>CE(sat)</sub> ≤ 6.0V**



TO-263HV (IXBA)



TO-268HV (IXBT)



G = Gate      C = Collector  
E = Emitter    Tab = Collector

Symbol	Test Conditions	Maximum Ratings	
V <sub>CES</sub>	T <sub>C</sub> = 25°C to 150°C	1700	V
V <sub>CGR</sub>	T <sub>J</sub> = 25°C to 150°C, R <sub>GE</sub> = 1MΩ	1700	V
V <sub>GES</sub>	Continuous	± 20	V
V <sub>GEM</sub>	Transient	± 30	V
I <sub>C25</sub>	T <sub>C</sub> = 25°C	16	A
I <sub>C90</sub>	T <sub>C</sub> = 90°C	10	A
I <sub>CM</sub>	T <sub>C</sub> = 25°C, 1ms	40	A
SSOA (RBSOA)	V <sub>GE</sub> = 15V, T <sub>VJ</sub> = 125°C, R <sub>G</sub> = 33Ω Clamped Inductive Load	I <sub>CM</sub> = 40 1350	A V
t <sub>sc</sub> (SCSOA)	V <sub>GE</sub> = 15V, V <sub>CE</sub> = 1200V, T <sub>J</sub> = 125°C R <sub>G</sub> = 33Ω, Non Repetitive	10	μs
P <sub>c</sub>	T <sub>C</sub> = 25°C	150	W
T <sub>J</sub>		-55 ... +150	°C
T <sub>JM</sub>		150	°C
T <sub>stg</sub>		-55 ... +150	°C
T <sub>L</sub>	Maximum Lead Temperature for Soldering	300	°C
T <sub>SOLD</sub>	Plastic Body for 10s	260	°C
F <sub>c</sub>	Mounting Force (TO-263)	10..65 / 22..14.6	N/lb
Weight	TO-263	2.5	g
	TO-268	4.0	g

Symbol	Test Conditions	Characteristic Values		
	(T <sub>J</sub> = 25°C Unless Otherwise Specified)	Min.	Typ.	Max.
BV <sub>CES</sub>	I <sub>C</sub> = 250μA, V <sub>GE</sub> = 0V	1700		V
V <sub>GE(th)</sub>	I <sub>C</sub> = 250μA, V <sub>CE</sub> = V <sub>GE</sub>	2.5		V
I <sub>CES</sub>	V <sub>CE</sub> = 0.8 • V <sub>CES</sub> , V <sub>GE</sub> = 0V			50 μA
	T <sub>J</sub> = 125°C			1.5 mA
I <sub>GES</sub>	V <sub>CE</sub> = 0V, V <sub>GE</sub> = ± 20V		±100	nA
V <sub>CE(sat)</sub>	I <sub>C</sub> = 10A, V <sub>GE</sub> = 15V, Note 1		6.0	V
	T <sub>J</sub> = 125°C	5.0		V

### Features

- High Voltage Package
- High Blocking Voltage
- Anti-Parallel Diode
- Low Conduction Losses

### Advantages

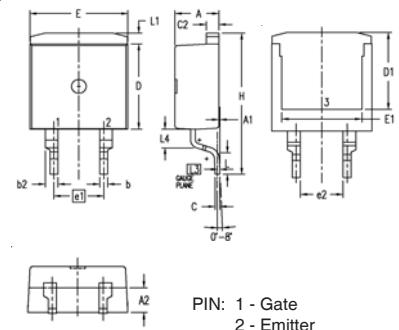
- Low Gate Drive Requirement
- High Power Density

### Applications:

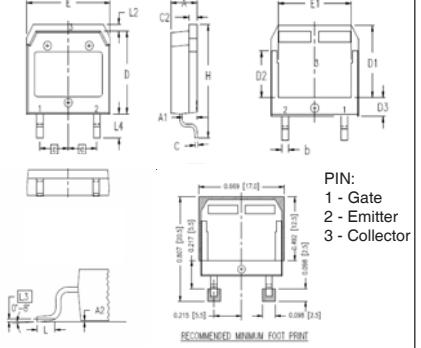
- Switch-Mode and Resonant-Mode Power Supplies
- Uninterruptible Power Supplies (UPS)
- Laser Generators
- Capacitor Discharge Circuits
- AC Switches

**Symbol Test Conditions**  
 $(T_J = 25^\circ\text{C} \text{ Unless Otherwise Specified})$ 

		Characteristic Values		
		Min.	Typ.	Max.
$g_{fs}$	$I_C = 10\text{A}, V_{CE} = 10\text{V}$ , Note 1	8.0	12.5	S
$C_{ies}$		1400		pF
$C_{oes}$	$V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$	90		pF
$C_{res}$		31		pF
$Q_{g(on)}$		65		nC
$Q_{ge}$	$I_C = 10\text{A}, V_{GE} = 15\text{V}, V_{CE} = 0.5 \cdot V_{CES}$	13		nC
$Q_{gc}$		22		nC
$t_{d(on)}$		15		ns
$t_{ri}$	$I_C = 10\text{A}, V_{GE} = 15\text{V}$	25		ns
$t_{d(off)}$	$V_{CE} = 0.8 \cdot V_{CES}, R_G = 10\Omega$	160	250	ns
$t_{fi}$		50	100	ns
$E_{off}$	Note 2		1.2	2.5 mJ
$t_{d(on)}$		15		ns
$t_{ri}$	$I_C = 10\text{A}, V_{GE} = 15\text{V}$	28		ns
$E_{on}$		2.0		mJ
$t_{d(off)}$	$V_{CE} = 0.8 \cdot V_{CES}, R_G = 10\Omega$	220		ns
$t_{fi}$		150		ns
$E_{off}$	Note 2		2.6	mJ
$R_{thJC}$			0.83	°C/W

**TO-263HV Outline**

PIN: 1 - Gate  
2 - Emitter  
3 - Collector

SYM	INCHES		MILLIMETER	
	MIN	MAX	MIN	MAX
A	.170	.185	4.30	4.70
A1	.000	.008	0.00	0.20
A2	.091	.098	2.30	2.50
b	.028	.035	0.70	0.90
b2	.046	.054	1.18	1.38
C	.018	.024	0.45	0.60
C2	.049	.055	1.25	1.40
D	.354	.370	9.00	9.40
D1	.311	.327	7.90	8.30
E	.386	.402	9.80	10.20
E1	.307	.323	7.80	8.20
e1	.200	BSC	5.08	BSC
(e2)	.163	.174	4.13	4.43
H	.591	.614	15.00	15.60
L	.079	.102	2.00	2.60
L1	.039	.055	1.00	1.40
L3	.010	BSC	0.254	BSC
(L4)	.071	.087	1.80	2.20

**TO-268HV Outline**

PIN:  
1 - Gate  
2 - Emitter  
3 - Collector

SYM	INCHES		MILLIMETER	
	MIN	MAX	MIN	MAX
A	.193	.201	4.90	5.10
A1	.106	.114	2.70	2.90
A2	.001	.010	0.02	0.25
b	.045	.057	1.15	1.45
C	.016	.026	0.40	0.65
C2	.057	.063	1.45	1.60
D	.543	.551	13.80	14.00
D1	.465	.476	11.80	12.10
D2	.295	.307	7.50	7.80
D3	.114	.126	2.90	3.20
E	.624	.632	15.85	16.05
E1	.524	.535	13.30	13.60
(e2)	.215	BSC	5.45	BSC
H	.736	.752	18.70	19.10
L	.067	.079	1.70	2.00
L2	.039	.045	1.00	1.15
L3	.010	BSC	0.25	BSC
L4	.150	.161	3.80	4.10

**ADVANCE TECHNICAL INFORMATION**

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

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IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2 4,860,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

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